

Vishay General Semiconductor

Surface Mount Glass Passivated Ultrafast Rectifier

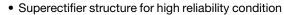
SUPERECTIFIER®



DO-214BA (GF1)

PRIMARY CHARACTERISTICS			
I _{F(AV)}	1.0 A		
V_{RRM}	1300 V		
I _{FSM}	20 A		
t _{rr}	75 ns		
E _{AS}	15 mJ		
T _J max.	150 °C		

FEATURES





RoHS

- · Cavity-free glass-passivated junction
- Ideal for automated placement
- Ultrafast reverse recovery time
- Situates reverse recovery time
- Low switching losses, high efficiency
- · Avalanche surge energy capability
- Meets environmental standard MIL-S-19500
- Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in high voltage rectification of photoflash application.

MECHANICAL DATA

Case: DO-214BA, molded plastic over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	EGF1T	UNIT
Device marking code		ET	
Maximum repetitive peak reverse voltage	V _{RRM}	1300	V
Maximum RMS voltage	V _{RMS}	910	V
Maximum DC blocking	V_{DC}	1300	V
Maximum average forward rectified current	I _{F(AV)}	1.0	А
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	20	А
Non-repetitive avalanche energy at T _A = 25 °C, I _{AS} = 1 A, L = 30 mH	E _{AS}	15	mJ
Operating junction and storage temperature range	T_J , T_{STG}	- 55 to + 150	°C



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	TEST CONDITIONS		SYMBOL	EGF1T	UNIT
Maximum instantaneous forward voltage	1.0 A	T _J = 25 °C	V _F ⁽¹⁾	3.0	V
Maximum DC reverse current	V _{RM}	T _J = 25 °C	- Ι _R ⁽²⁾	5.0	μΑ
		T _J = 125 °C		50	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		t _{rr}	75	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	8.0	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	EGF1T	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾	50	°C/W	
Typical thermal resistance	R _{0JL} (1)	20	C/VV	

Note

(1) Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.95" x 0.95" (24 mm x 24 mm) copper pad areas

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
EGF1T-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel	
EGF1T-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and reel	
EGF1THE3/67A (1)	0.104	67A	1500	7" diameter plastic tape and reel	
EGF1THE3/5CA (1)	0.104	5CA	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

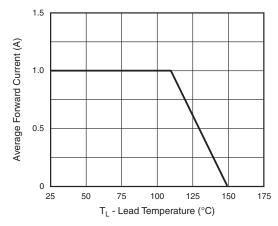


Fig. 1 - Maximum Forward Current Derating Curve

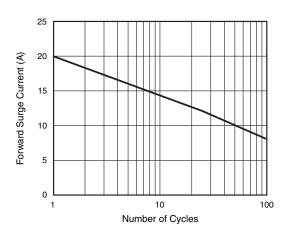


Fig. 2 - Maximum Non-Repetitive Forward Surge Current



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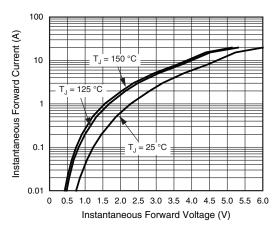


Fig. 3 - Typical Instantaneous Forward Characteristics

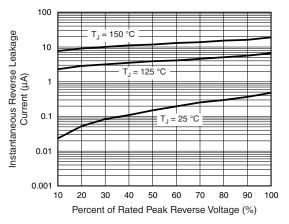


Fig. 4 - Typical Reverse Leakage Characteristics

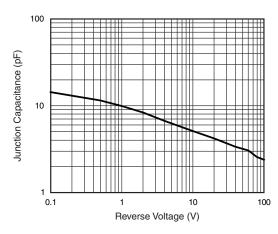


Fig. 5 - Typical Junction Capacitance Per Leg

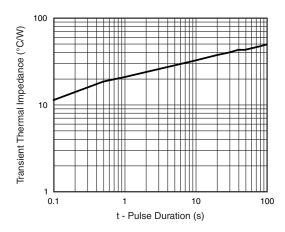
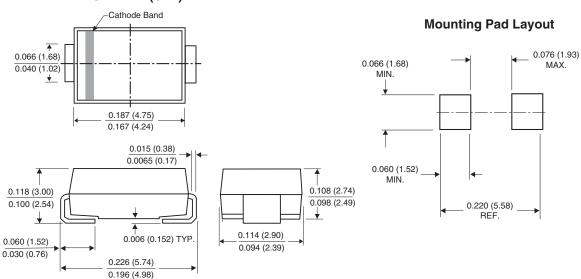


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214BA (GF1)





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